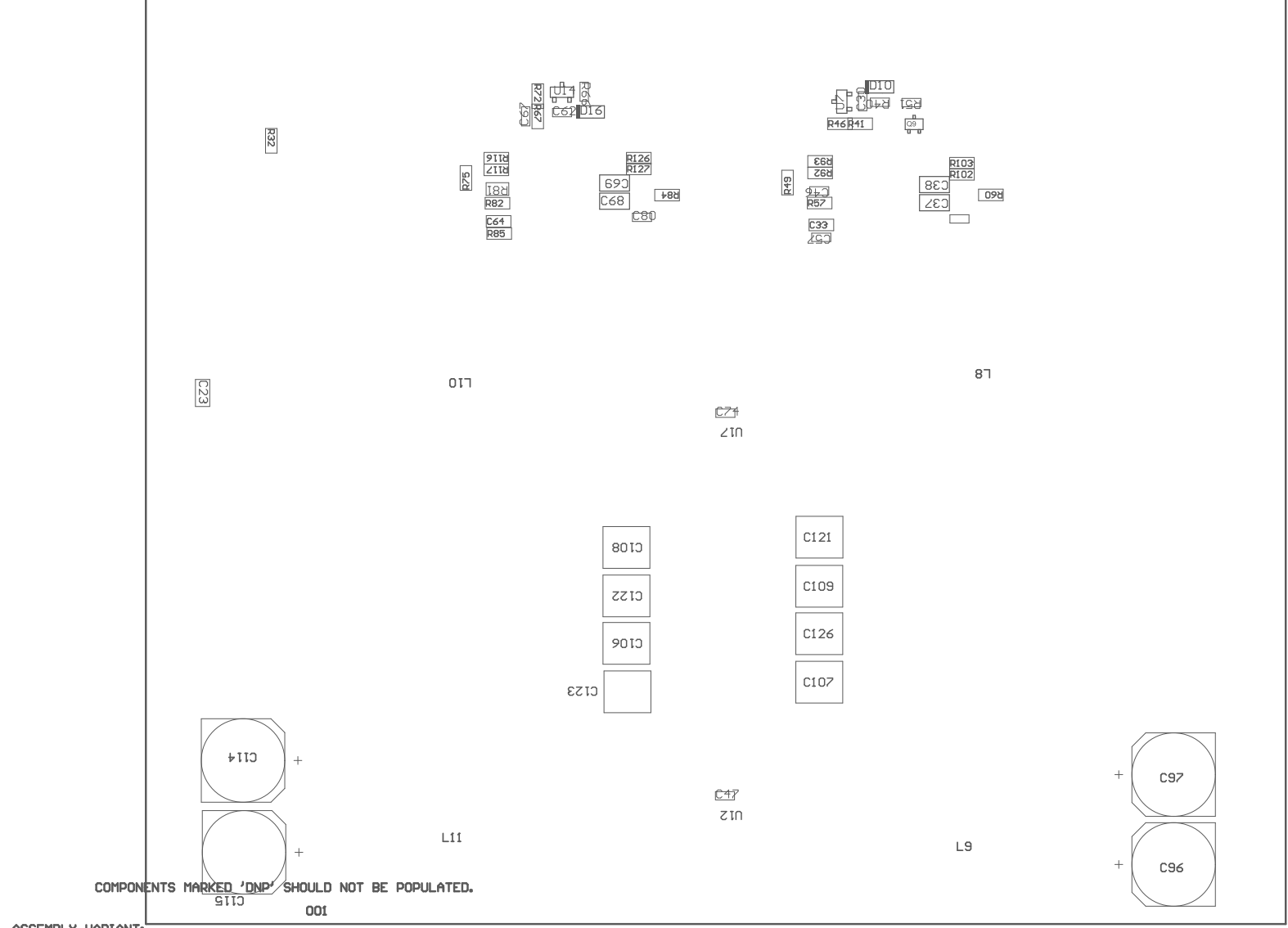


PCB VIEWED FROM TOP SIDE	BOARD #: PMP15035	REV: E1	SUN REV: Not In VersionControl
	TID #: N/A		
PLOT NAME = Top Assembly Drawing	GENERATED : 6/14/2018	5:53:38 PM	TEXAS INSTRUMENTS



PCB VIEWED FROM BOTTOM SIDE	BOARD #: PMP15035	REV: E1	SUN REV: Not In VersionControl
	TID #: N/A		
PLOT NAME = Bottom Assembly Drawing	GENERATED : 6/14/2018	5:53:40 PM	TEXAS INSTRUMENTS

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